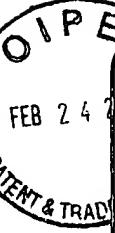


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Approved for use through 10/31/2002. OMB 0651-0031

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Total Number of Pages in This Submission

12

Application Number

09/453,055

Filing Date

December 2, 1999

First Named Inventor

Eikatsu Yamaguchi

Group Art Unit

1733

Examiner Name

J. Aftergut

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Attorney Docket Number

032405.027

ENCLOSURES (check all that apply)

 Fee Transmittal Form Assignment Papers
(for an Application) After Allowance Communication to Group Fee Attached Drawing(s) Appeal Communication to Board of Appeals and Interferences Amendment / Response Licensing-related Papers Appeal Communication to Group
(Appeal Notice, Brief, Reply Brief) After Final Petition Proprietary Information Affidavits/declaration(s) Petition to Convert to a Provisional Application Status Letter Extension of Time Request Power of Attorney, Revocation Change of Correspondence Address Other Enclosure(s)
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Remarks

 Response to Missing Parts/ Incomplete Application Response to Missing Parts under 37 CFR 1.52 or 1.53

SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT

Firm
or
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Robert G. Weilacher

Signature

Date

February 18, 2003

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Docket No. 2032405.02

18/1-(E)
A.L.H.
2-28-03

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: **EIKATSU YAMAGUCHI, et al.**

Serial No.: **09/453,055**

Examiner: **J. Aftergut**

Filed: **December 2, 1999**

Art Unit: **1733**

For: **METHOD OF FORMING HONEYCOMB SANDWICH
COMPOSITE PANELS**

AMENDMENT AFTER FINAL

Assistant Commissioner for Patents

Washington, D.C. 20231

Sir:

Entry of the following amendment is respectfully requested for the purpose of placing the application in condition for allowance, or alternatively, in better condition for appeal.

IN THE CLAIMS:

Please amend Claims 2 and 19, as follows:

2. (Three Times Amended) A method of forming a honeycomb sandwich composite panel by a resin transfer molding process consisting of:

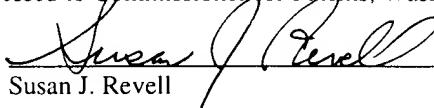
stacking a thermosetting sealing material on at least one side of a honeycomb core, said thermosetting sealing material having an adhesive property and being a resin film including glass microspheres;

stacking a dry fabric on said thermosetting sealing material;

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Susan J. Revell